



## TSC1641: I3C capabilities

## **Introduction**

The TSC1641 is a current, voltage, DC power, and temperature monitoring analog front-end (AFE). It has a double ADC-path for current and voltage to ensure the most accurate DC power computation. Programmable conversion timing and configuration modes make the device flexible to use and suitable for many systems. Alert signals can be raised on a dedicated pin upon several conditions.

The TSC1641 is a MIPI I3C™ SDR target that complies with all the requirements of the BASICS V1.1.

The MIPI I3C™ is a modern bus, which has useful features such as in-band-interruption and dynamic address assignation.

This application note gives the basic information to start using the TSC1641 on a MIPI I3C™ bus.

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## **1 Glossary and acronyms**

I3C: MIPI improved inter-integrated circuit interface.

I²C: Inter-integrated circuit. Two-wire communication protocol for connecting multiple devices, allowing data exchange and control within electronic systems.

SCL: Clock line.

SDA: Data line.

IBI: In-band interrupt.

An in-band-interrupt is an interruption triggered by a target. The target initiates a start request while the I3C bus is idle, by pulling the SDA low while the SCL is high.

The controller can then either proceed to a Nack or launch a clock pattern to give the target the possibility to talk. HJ: Hot-join.

A hot-join is an optional feature that a target can have. A hot-join request is carried out by a target, which is not integrated in the I3C bus, to ask to the controller to join the bus.

CCC: Common command code.

A set of CCCs are available and described in the basic specifications of the I3C bus written by the MIPI alliance. Each CCC can ask or write to a device for specific information.

Not all CCCs are mandatory for a target or a device.

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## **2 Introduction to I3C™ and comparison with I²C**

MIPI I3C™ is a standardized bus, managed by the MIPI alliance. Its specifications are aimed at becoming a standard in most use-cases such as the automotive industry, internet-of-things, and manufacturing.

The goal of this bus is to improve and ease sensor integration in systems. It allows the development of more complex and intelligent devices to be implemented in systems by having flexible features.

## **2.1 Comparison with I²C**

I3C (MIPI I3C) offers several advantages over its predecessor I²C (inter-integrated circuit). The following are some reasons why I3C is considered better than I<sup>2</sup>C:

Enhanced data transfer rates: I3C provides significantly higher data transfer rates compared to I²C. While I²C typically operates at speeds up to a few hundred kilobits per second, I3C supports faster data rates up to 12.5 MHz.

Backward compatibility: I3C maintains backward compatibility with I²C, meaning I²C devices can be easily connected to an I3C bus without requiring any modifications. This compatibility ensures a smooth transition from I²C to I3C, allowing existing I²C devices to coexist with newer I3C devices on the same bus. This feature makes I3C a viable and convenient choice for system upgrades.

Reduced pin count and power consumption: I3C reduces pin count and power consumption compared to I²C. I3C does not require pull-up resistors. Moreover, I3C supports an in-band-interrupt feature so that an additional "alert" pin is not used. See [Section 2.2.3](#page-4-0).

Dynamic addressing and device enumeration: With I²C, device addresses are assigned statically, limiting the number of devices that can be connected to the bus. In contrast, I3C supports dynamic address assignment, allowing devices to be added or removed from the bus without conflicts. This flexibility enables scalability and simplifies system integration.

Improved bus management and control: I3C introduces advanced bus management and control features, such as hot join detection, and multi-controller support. These features enhance bus reliability, enable efficient power management, and facilitate seamless communication between devices. I²C lacks these capabilities, making I3C a more robust and versatile interface for complex system architectures.

Standardized protocol: I3C is an industry-standard protocol developed by the MIPI alliance, ensuring interoperability and widespread adoption among different manufacturers. This standardization promotes compatibility, simplifies integration, and enables a broader ecosystem of I3C-compliant devices and components.

In summary, I3C offers higher data transfer rates, backward compatibility with I<sup>2</sup>C, reduced pin count and power consumption, dynamic addressing, advanced bus management features, and standardized protocol. These advantages make I3C a more capable and future-proof interface, suitable for demanding applications requiring faster and more efficient communication between devices.



#### **Table 1. Comparison between I3C and I²C**

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## **2.2 Main MIPI I3C™ features implemented in the TSC1641**

MIPI I3C™ embeds several features requested for modern applications, and many of these are implemented in the TSC1641:

- Support of 3.3 V
- Backward compatibility with I²C
- Dynamic address only (the controller does not need to know the hardware address of the TSC1641)
- Passive hot-join (the TSC1641 asks to join the I3C bus if it sees an I3C communication)
- In-band-interrupts (the TSC1641 can trigger alerts directly on the I3C bus)

### **2.2.1 Communication speed**

I3C frames are made of an open-drain part and a push-pull part. The TSC1641 is able to communicate in I3C SDR mode only and up to 12.5 MHz.

#### **Table 2. Communication speeds**



### **2.2.2 Accepted CCC commands**

Moreover, the TSC1641 can understand the majority of CCC commands.

<span id="page-4-0"></span>In Table 3. List of available CCCs the most important CCC commands accepted by the TSC1641 are described.



### **Table 3. List of available CCCs**

*1. NA: Some CCCs do not exist in direct or broadcast format.*

#### **2.2.3 In-band interruptions (IBI)**

The TSC1641 has several alerts that can be activated.

These alerts are usable in I<sup>2</sup>C and I3C. In I<sup>2</sup>C the alerts are monitored by the designated alert pin.

In I3C, the use of the alert pin may be avoided due to the IBI feature. In I3C, when an alert is generated by the component, it rises directly on the bus.

The TSC1641 can trigger alerts directly on the I3C bus.

These alerts are set by the mask register as seen in [Table 4](#page-5-0) and limits registers (registers 0x09 to 0x0E). It is possible to enable or disable different kinds of alerts by writing into the register.

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#### **Table 4. Mask register (0x06)**

If the device is in I3C mode (i.e. a dynamic address has been assigned to the TSC1641) and the in-bandinterruption feature is activated, then an alert is triggered on the designated ALERT pin and simultaneously on the I3C bus.

In Figure 1, an IBI may be seen on the I3C bus by the TSC1641. The device gives its address (in this case the address is 08) to inform the controller. Note that the alert pin (at the bottom) and the interruption are triggered almost simultaneously.



#### **Figure 1. In-band interrupt initiated by the TSC1641**

#### **2.2.4 Hot-join**

Hot-join is a feature in the I3C interface that enables devices to be dynamically added or removed from the bus without disrupting the ongoing communication. It allows for seamless integration of devices in an I3C bus network, even while the bus is operational.

Hot-join brings several benefits to the I3C bus network. It allows for flexible system expansion, as devices can be added or removed dynamically during runtime without requiring system-wide resets or disruptions. It simplifies the integration process and reduces the need for manual configuration of addresses or bus parameters. Hot-join also enables the support of plug-and-play functionality, making it easier to connect and disconnect devices on the bus.

A device which is not on the bus initiates the hot-join. The device monitors the bus, observes an I3C communication on the bus, and requests to be added to the bus by pulling to low the SDA line.

## <span id="page-6-0"></span>**2.2.5 Bus characteristics register (BCR)**

The bus characteristic register is an 8-bit register describing the capabilities of the device regarding I3C. Each bit explains a capability of the device. The table below is an extract from the MIPI I3C basic specification (public version V1.1.1). The full table is available on the member version of the I3C basic specification V1.1.1. By sharing this register with other devices, it allows other devices to know and understand the capabilities of the device and communicate efficiently with it.



### **Table 5. Bit meaning for BCR value**

The TSC1641 BCR register contains the value 0x02 or 0b0000 0010. The meaning for the TSC1641 is explained in [Table 6](#page-7-0).

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### **Table 6. TSC1641 BCR value explanation**





## **2.2.6 DCR device characteristics register**

The DCR (device characteristic register) is a register containing the kind of device (i.e. touch sensor, ECG, etc.). The TSC1641 DCR value is 0x00, the ID for a generic component.

### **2.2.7 GETCAPS**

The "GETCAPS" command in I3C (MIPI I3C) is used to retrieve the device capabilities from another I3C device on the bus. It is a command initiated by a controller device to query the capabilities of a specific target device.

When a controller device sends a GETCAPS command to a target device, the target device responds by providing information about its supported features, functionalities, and operating modes.

The GETCAPS command allows the controller device to dynamically discover and understand the capabilities of the target device. It helps the controller device to determine how to interact with the target device effectively and utilize its specific features or functionalities.

By retrieving the device capabilities through the GETCAPS command, the controller device can make informed decisions about communication settings, protocols, power management, and other parameters. This enables efficient use of the target device's capabilities and promotes optimized communication within the I3C bus network.

In summary, the GETCAPS command in I3C facilitates the exchange of device capability information between devices on the bus, enabling better coordination and use of the available features and functionalities.



The TSC1641 answers to the GETCAPS command:

- 0x00:
	- $-$  It is not HDR  $(1)$  compatible
- *1. HDR: High data rate is an optional I3C feature.*
- 0x11:
	- Can be assigned to one group address
	- TSC1641 complies with MIPI I3C Basic V1.1
- 0x18:
	- TSC1641 support optional defining byte on GETSTATUS
		- The defining byte is 0x00
	- TSC1641 support optional defining byte on GETCAPS
		- The defining byte is 0x00
- 0x00

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## **3 Typical schematic**

I3C frames are made of push-pull and open drain parts. There is no need for pull-up resistors on the boards. This reduces the number of components needed and makes the layout easier to design and reduces consumption.





As shown, alerts are directly triggered on the I3C bus thanks to the SDA line. So, it is not necessary to connect the ALERT pin.



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## **4 Dynamic address assignation**

To enter in I3C mode, the TSC1641 must receive a dynamic address from a microcontroller. There are several ways to assign a dynamic address to the TSC1641.

## **4.1 Use of static address as a dynamic address**

The TSC1641 accepts the CCC SETAASA.

This command is sent to all targets connected to the bus. With this command, all the targets use their respective static address as their dynamic address.



#### **Figure 4. CCC SETAASA by broadcast.**

After this CCC command, the device is accessible in I3C with its static address. The static address depends on the A0 and A1 pins.



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#### **Figure 5. In this example the static address is 0x40, after the CCC SETAASA the I3C dynamic address also becomes 0x40. This frame shows the Die ID register (0xFF register).**



## **4.2 Assignment of a dynamic address thanks to the static address**

### The TSC1641 accepts the CCC SETDASA.

In other words, the TSC1641 in I<sup>2</sup>C mode can be put in I3C mode thanks to its I<sup>2</sup>C static address. The controller chooses a new dynamic address, and it is given to the TSC1641.

It differs from the SETAASA because it is a direct command (it is addressed to only one target) and the controller chooses the new dynamic address given to the target. The new dynamic address does not depend on the static address of the target.

## **4.3 Assignment of dynamic address thanks to bus exploration**

This is an interesting and useful feature of the I3C bus.

The controller can explore the I3C bus looking for new targets to add to the bus.

For each target able to join the I3C bus, the controller proceeds into a specific dynamic address assignment process: the ENTDAA.

<span id="page-12-0"></span>The controller broadcasts on the bus the CCC ENTDAA, and for each target responding to this command, a dynamic address is assigned in exchange for PID (a unique code for each target allowing to pair PID-dynamic addresses) and BCR and DCR codes (a code giving information about target capabilities). The figure below shows the ENTDAA process, in which two targets are discovered and added to the bus by the controller. During the ENTDAA process, BCR, DCR, and PID are shared by the target. In exchange, the controller assigns a dynamic address to each target (here 0x08 and 0x09).



#### **Figure 6. The ENTDAA process**

## **4.4 Passive hot-join**

Passive hot-join is a feature that allows the TSC1641 to join an existing I3C bus network without actively initiating the hot-join process. In a passive hot-join, the new device listens to the bus and detects ongoing communication before asking to join by pulling the SDA line low.

When in I<sup>2</sup>C mode, the TSC1641 continuously monitors the I3C bus for activity and waits for a trigger condition to occur. This trigger condition is a bus IDLE of 200 µs. Once the trigger is detected, the TSC1641 initiates the hotjoin process, following the standard hot-join procedure as described in the I3C basic V1.1.1. In Figure 7, the first frame on the left is an I3C communication (a GETBCR, more precisely) between the controller and a device on the bus. The TSC1641 reads the I3C bus and sees this communication. After 200 us of inactivity on the bus, the device asks to be added.





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In Figure 8, the TSC1641 pulls the SDA line low. The controller allows the target to communicate by launching a clock signal. Then, the broadcast address 0x02 (hot-join) is sent by the TSC1641. The controller then launches an ENTDAA process to add the device.







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## **5 Application to a use-case: electrical skateboard**

## **5.1 Purpose of the demonstration**

This demo was presented during the embedded world forum 2023 in Nuremberg.

### **Figure 9. Skateboard demo using the TSC1641 and the STM32H5 to communicate in I3C**



The demo highlights the specificity in that it uses only the I3C bus to communicate.

The goal of this demo is to monitor the battery voltage of an electric skateboard battery pack and measure the current consumption of the electric skateboard.

The skateboard motor speed is controlled by a remote controller. If the speed is too high or too low, an alert must be triggered by the TSC1641 directly on the I3C bus.

The TSC1641 also uses the in-band interrupt feature to send alerts on the I3C bus when the current is too high or too low according to the thresholds set. [Figure 10](#page-15-0) shows the current and voltage measurements of the skateboard. The current is above the shunt under limit threshold of 10 mA and below the shunt over limit threshold of 200 mA, so no alert is triggered. At the bottom of the screen-shot are the current alert states. These alerts are triggered via in-band interrupts by the TSC1641 on the I3C bus.

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**Figure 10. The current and voltage measurement on the skateboard**

## **5.2 Block diagram**

The TSC1641 (placed on the STEVAL-DIGAFEV1) has two separate modulators to monitor voltage and current.



#### **Figure 11. Schematic diagram**

On the one hand, the battery is connected to the VLOAD TSC1641 input. This input is connected to the modulator to monitor voltage.

On the other hand, the current is monitored by an external shunt resistor by measuring the voltage drop surrounding the resistor by inputs in+ and in-.

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#### **Figure 12. Block diagram**



## **5.3 Communication between the controller and the target**

The bus is composed of the STM32H5 and the TSC1641. The controller is STM35H5, which is located on the Nucleo-STM32H503RB. The target is TSC1641, located on the STEVAL-DIGAFEV1.

### **5.3.1 Addition of the TSC1641 to the I3C bus**

The first step is to add the TSC1641 to the I3C bus. As previously mentioned, the TSC1641 may be added to the bus via several ways.

In the case of this demo, the method used is the ENTDAA (the controller discovers the bus and assigns an address to each target encountered).



#### **Figure 13. ENTDAA, the STM32H5 adds the TSC1641 on the bus and gives it the dynamic address 0x32**

Going forward, the TSC1641 is in I3C mode and can respond to I3C commands only.

## **5.3.2 Enabling the alert and setting the thresholds**

At this point, the TSC1641 can communicate in I3C.

To trigger alerts on overcurrent and undercurrent, we must enable these alerts by setting the mask register.



#### **Table 8. Mask register**

These two alerts are:

- SOL: shunt over limit



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### - SUL: shunt under limit

As shown in table 8, bits 15 and 14 must be set to 1 to enable SOL and SUL alerts.



**Figure 14. Write on mask register**

Now the alerts are activated, but the thresholds must be set.

### **Figure 15. Threshold written in SOL register**



Accordingly, the TSC1641 monitors the current and triggers an in-band interrupt on the I3C when the current is too low or too high according to the previously set threshold.

## **5.3.3 In-band interrupt and read of flag register**

When the current is too high or too low, an alert is triggered. Simultaneously, an in-band-interrupt is generated on the I3C bus (as explained in the dedicated part).

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Then, the microcontroller reads the flag register to know which alert has been triggered.



## **Figure 16. Read of the flag register**

The flag register contains the value 0x0020.

In this case, the only alert activated is SUF (shunt under limit flag), meaning that the current is under the previously set threshold.

**Table 9. Flag register, each bit corresponds to an alert. If the bit = 1 an alert is triggered.**



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## **Revision history**

## **Table 10. Document revision history**



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